

Main Product Characteristics:

IF	20A
VRRM	60V
T _j (max)	150 ℃
Vf(max)	0.5V



TO-277 SSTS20U60P5-HF

Schematic Diagram

Features and Benefits:

- High Junction Temperature
- High ESD Protection
- High Forward & Reverse Surge capability



Description:

Schottky Barrier Rectifier designed for high frequency switch model power supplies such as adaptors and DC/DC convertors; this product special design for high forward and reverse surge capability

Absolute Rating:

Symbol	Characterizes	Value	Unit
V_{RRM}	Peak Repetitive Reverse Voltage	60	V
$V_{R(RMS)}$	RMS Reverse Voltage	42	V
I _{F(AV)}	Average Forward Current	20	Α
I _{FSM}	Non Repetitive Surge Forward Current(tp=8.3ms sinusoidal)	200	Α
I _{RRM}	Peak Repetitive Reverse Surge Current(Tp=2us)	0.5	Α
T_J	Maximum operation Junction Temperature Range	-55~150	$^{\circ}$
T_{stg}	Storage Temperature Range	-55~150	$^{\circ}$

Thermal Resistance

Symbol	Characterizes	Value	Unit
$R_{\theta JA}$	Maximum Thermal Resistance Junction To Ambient	73	℃W

Electrical Characterizes @T_A=25 °C unless otherwise specified

Symbol	Characterizes	Min	Тур	Max	Unit	Test Condition
V_R	Reverse Breakdown Voltage	60			V	I _R =0.5mA
V _F	Forward Voltage Drop		0.33	0.35	V	I _F =3A, T _J =25°C
			0.5	0.55		IF=20A, T _J =25℃
			0.21			I _F =3A, T _J =125℃
			0.5			I _F =20A, T _J =125℃
I _R	Leakage Current		0.1	0.2	mA	V _R =60V, T _J =25°C
			30	100		V _R =60V, T _J =125℃

Version: 1.0

1of5

page



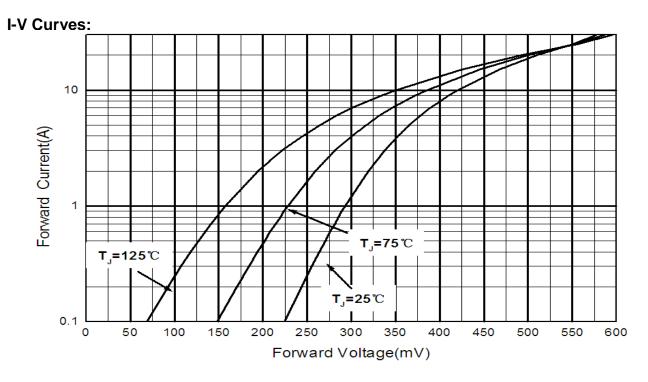


Figure 1: Typical Forward Characteristics

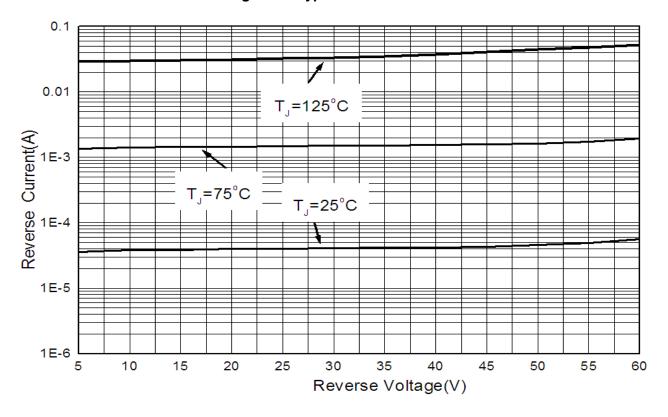


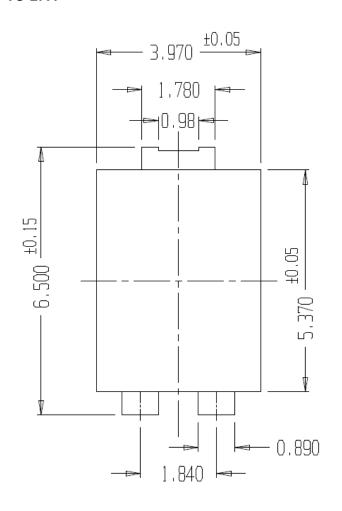
Figure 2: Typical Reverse Characteristics

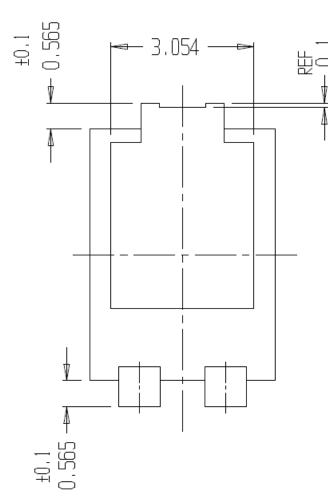


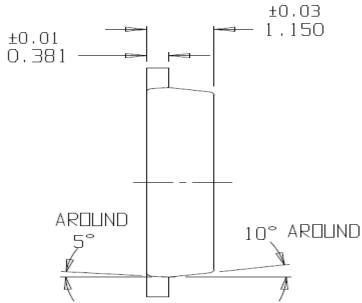


Mechanical Data:

TO-277:









Ordering and Marking Information

Device Marking: SSTS20U60P5

Package (Available)
TO-277
Operating Temperature Range
C: -55 to 150 °C

Devices per Unit

Packag e Type	Units/ Tube	Tubes/ Inner Box	Units/ Inner Box	Inner Boxes/Carton Box	Units/ Carton Box
		DOX	DOX	DOX	DOX

Reliability Test Program

Test Item	Conditions	Duration	Sample Size
High	Tj=125℃ to 150℃ @	168 hours	3 lots x 77 devices
Temperature	80% of Max	500 hours	
Reverse	VDSS/VCES/VR	1000 hours	
Bias(HTRB)			



5of5

page

Version: 1.0



ATTENTION:

- Any and all Silikron products described or contained herein do not have specifications that can handle applications that require extremely high levels of reliability, such as life-support systems, aircraft's control systems, or other applications whose failure can be reasonably expected to result in serious physical and/or material damage. Consult with your Silikron representative nearest you before using any Silikron products described or contained herein in such applications.
- Silikron assumes no responsibility for equipment failures that result from using products at values that exceed, even momentarily, rated values (such as maximum ratings, operating condition ranges, or other parameters) listed in products specifications of any and all Silikron products described or contained herein.
- Specifications of any and all Silikron products described or contained herein stipulate the performance, characteristics, and functions of the described products in the independent state, and are not guarantees of the performance, characteristics, and functions of the described products as mounted in the customer's products or equipment. To verify symptoms and states that cannot be evaluated in an independent device, the customer should always evaluate and test devices mounted in the customer's products or equipment.
- Silikron Semiconductor CO.,LTD. strives to supply high-quality high-reliability products. However, any and all semiconductor products fail with some probability. It is possible that these probabilistic failures could give rise to accidents or events that could endanger human lives, that could give rise to smoke or fire, or that could cause damage to other property. When designing equipment, adopt safety measures so that these kinds of accidents or events cannot occur. Such measures include but are not limited to protective circuits and error prevention circuits for safe design, redundant design, and structural design.
- In the event that any or all Silikron products(including technical data, services) described or contained herein are controlled under any of applicable local export control laws and regulations, such products must not be exported without obtaining the export license from the authorities concerned in accordance with the above law.
- No part of this publication may be reproduced or transmitted in any form or by any means, electronic or mechanical, including photocopying and recording, or any information storage or retrieval system, or otherwise, without the prior written permission of Silikron Semiconductor CO.,LTD.
- Information (including circuit diagrams and circuit parameters) herein is for example only; it is not guaranteed for volume production. Silikron believes information herein is accurate and reliable, but no guarantees are made or implied regarding its use or any infringements of intellectual property rights or other rights of third parties.
- Any and all information described or contained herein are subject to change without notice due to product/technology improvement, etc. When designing equipment, refer to the "Delivery Specification" for the Silikron product that you intend to use.

Customer Service

Worldwide Sales and Service:

Sales@silikron.com

Technical Support:

Technical@silikron.com

Suzhou Silikron Semiconductor Corp.

11A, 428 Xinglong Street, Suzhou Industrial Park, P.R.China

TEL: (86-512) 62560688 FAX: (86-512) 65160705

E-mail: Sales@silikron.com